

Electronic Patent Application Fee Transmittal

Application Number:	10660054			
Filing Date:	11-Sep-2003			
Title of Invention:	Method of manufacturing clad board for forming circuitry, clad board and core board for clad board			
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Filer:	Lawrence E. Ashery			
Attorney Docket Number:	MAT-8260US1			
Filed as Large Entity				
Utility under 35 USC 111(a) Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Total in USD (\$)				810